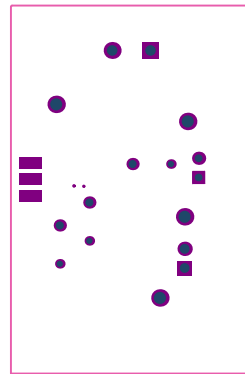
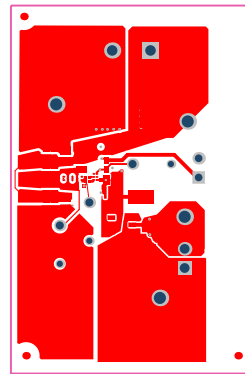


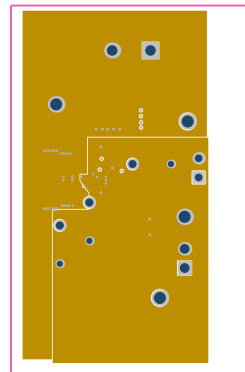
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01573		
PLOT NAME = Top Overlay	GENERATED : 2/9/2018	4:41:35 PM	TEXAS INSTRUMENTS



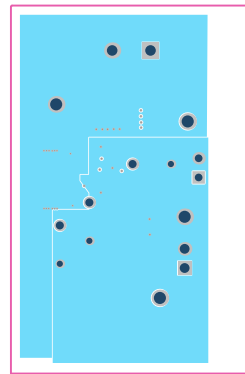
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01573		
PLOT NAME = Top Solder Mask	GENERATED : 2/9/2018 4:41:35 PM	TEXAS INSTRUMENTS	



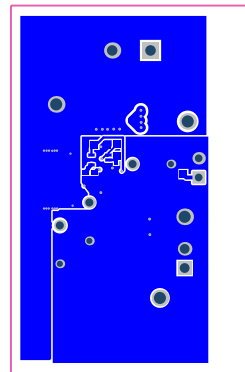
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01573		
PLOT NAME = Top Layer	GENERATED : 2/9/2018 4:41:35 PM	TEXAS INSTRUMENTS	



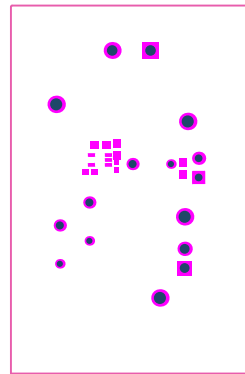
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01573		
PLOT NAME = Signal Layer 1	GENERATED : 2/9/2018 4:41:35 PM	TEXAS INSTRUMENTS	



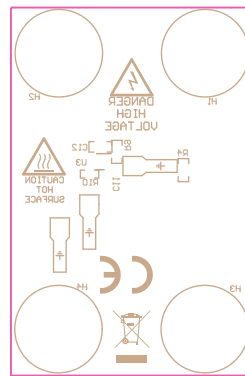
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01573		
PLOT NAME = Signal Layer 2	GENERATED : 2/9/2018 4:41:35 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01573		
PLOT NAME = Bottom Layer	GENERATED : 2/9/2018 4:41:35 PM	TEXAS INSTRUMENTS	

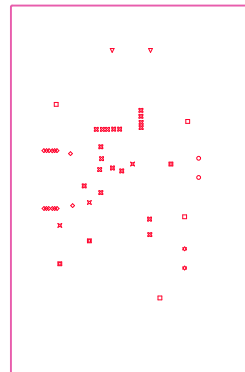


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01573		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/9/2018 4:41:35 PM	TEXAS INSTRUMENTS	



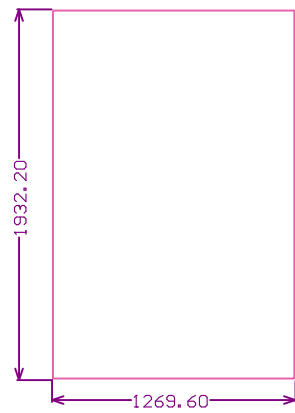
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01573		
PLOT NAME = Bottom Overlay	GENERATED : 2/9/2018 4:41:35 PM	TEXAS INSTRUMENTS	





Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Tolerance
◇	14	6.00mil (0.152mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	18	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
■	3	32.00mil (0.813mm)	PTH	Round	Top Layer - Bottom Layer	
○	2	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	3	42.00mil (1.067mm)	PTH	Round	Top Layer - Bottom Layer	
☆	2	51.18mil (1.300mm)	PTH	Round	Top Layer - Bottom Layer	
▽	2	55.12mil (1.400mm)	PTH	Round	Top Layer - Bottom Layer	
□	4	63.00mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	
	48 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01573		
PLOT NAME = Drill Drawing	GENERATED : 2/9/2018	4:41:36 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01573	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01573		
PLOT NAME = Board Dimensions	GENERATED : 2/9/2018 4:41:36 PM	TEXAS INSTRUMENTS	

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